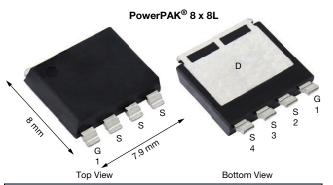
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N-Channel 40 V (D-S) 175 °C MOSFET



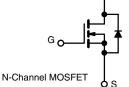
PRODUCT SUMMARY 40 V_{DS} (V) $R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V 0.00065 $R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5$ V 0.00094 Q_g typ. (nC) 75 450 I_D (A) ^a Configuration Single

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- Fully lead (Pb)-free device
- Very low R_{DS} x Q_g figure of merit (FOM)
- 50 % smaller footprint than D²PAK (TO-263)
- 100 % R_a and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- OR-ing
- Motor drive control
- Battery management



ORDERING INFORMATION	
Package	PowerPAK [®] 8 x 8L
l ead (Pb)-free and halogen-free	SIJH402F-T1-GE3

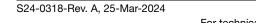
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage Gate-source voltage		V _{DS}	40	V
		V _{GS}	+20, -16	v
Continuous drain current (T _J = 175 °C)	T _C = 25 °C		450	
	T _C = 70 °C	Τ.Γ	376	
	T _A = 25 °C		46 ^b	
	T _A = 70 °C	1	38 ^b	
Pulsed drain current (t = 100 µs)		I _{DM}	800	— A
Continuous source-drain diode current	T _C = 25 °C		240	
	T _A = 25 °C	I _S	2.4 ^b	
Single pulse avalanche current		I _{AS}	73	
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	269	mJ
Maximum power dissipation	T _C = 25 °C		263	
	T _C = 70 °C		184	14/
	T _A = 25 °C	P _D	2.6 ^b	W
	T _A =70 °C	1	1.8 ^b	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	*0
Soldering recommendations (peak temperature) ^c			260	°C

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	MBOL TYPICAL MAXIMUM			
Maximum junction-to-ambient b	Steady state	R _{thJA}	42	57	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	0.41	0.57	0/10	

Notes a. T_C = 25 °C

b. Surface mounted on 1" x 1" FR4 board

b. Surface mounted on 1° x 1° FR4 board
c. See solder profile (www.vishay.com/doc?73257). The PowerPAK 8 x 8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
d. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components





COMPLIANT

HALOGEN FREE

D

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static					•	•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	40	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 10 mA	-	25	-	m\//°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-7.1	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.1	-	2.4	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = +20, -16$	-	-	± 100	nA	
Zere gete veltege drein eurrent	I _{DSS}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1		
Zero gate voltage drain current		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 70 ^\circ\text{C}$	-	-	15	μA	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.00050	0.00065	- Ω	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.00071	0.00094		
Forward transconductance ^a	g _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 40 \text{ A}$	-	215	-	S	
Dynamic ^b					•	•	
Input capacitance	C _{iss}	V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz	-	13 105	-	pF	
Output capacitance	C _{oss}		-	2470	-		
Reverse transfer capacitance	C _{rss}		-	165	-		
	Q _g -	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	166	250	nC	
Total gate charge		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	75	115		
Gate-source charge	Q _{gs}		-	39	-		
Gate-drain charge	Q _{gd}		-	18	-		
Gate resistance	R _q	f = 1 MHz	0.2	1.1	2.2	Ω	
Turn-on delay time	t _{d(on)}		-	22	45	-	
Rise time	tr	$V_{DD} = 40 \text{ V}, \text{ R}_{\text{I}} = 4 \Omega, \text{ I}_{\text{D}} \cong 10 \text{ A},$	-	16	30		
Turn-off delay time	t _{d(off)}	V_{GEN} = 10 V, R _g = 1 Ω	-	72	145		
Fall time	t _f		-	12	25		
Turn-on delay time	t _{d(on)}		-	72	145	ns	
Rise time	t _r	$V_{DD} = 40 \text{ V}, \text{ R}_{L} = 4 \Omega, \text{ I}_{D} \cong 10 \text{ A},$	-	128	260	-	
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	90	180		
Fall time	t _f		-	90	180		
Drain-Source Body Diode Characterist	cs				•	•	
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	240		
Pulse diode forward current	I _{SM}		-	-	800	A	
Body diode voltage	V _{SD}	$I_{S} = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.7	1.1	V	
Body diode reverse recovery time	t _{rr}		-	70	140	ns	
Body diode reverse recovery charge	Q _{rr}		-	122	245	nC	
Reverse recovery fall time	t _a	$I_{\rm F} = 10$ A, $dI/dt = 100$ A/µs, $I_{\perp} = 25$		41	-		
Reverse recovery rise time	t _b		-	29	-	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

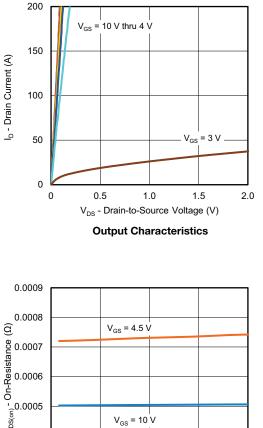
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

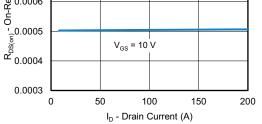
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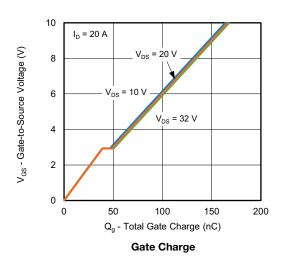
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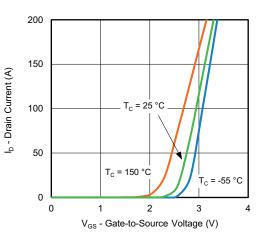
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



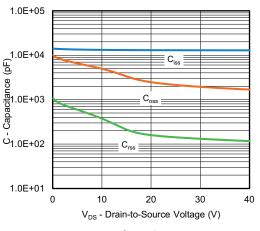


On-Resistance vs. Drain Current and Gate Voltage

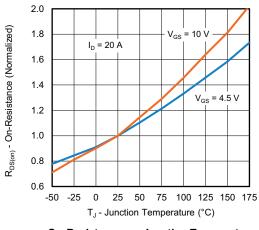




Transfer Characteristics







On-Resistance vs. Junction Temperature

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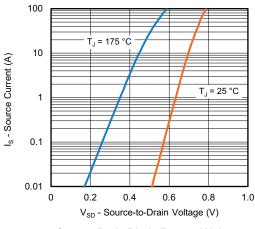
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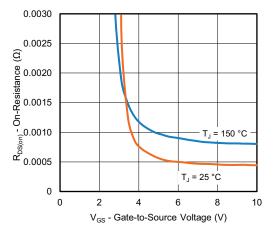


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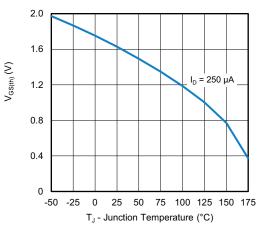


Source-Drain Diode Forward Voltage

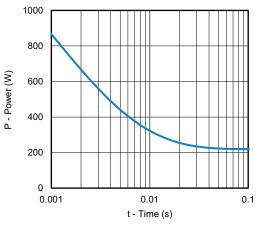


On-Resistance vs. Gate-to-Source Voltage

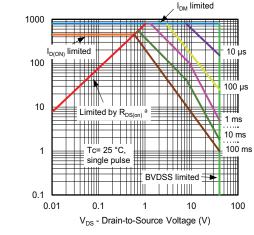
In - Drain Current (A)



Threshold Voltage



Single Pulse Power, Junction-to-Case



Safe Operating Area, Junction-to-Case

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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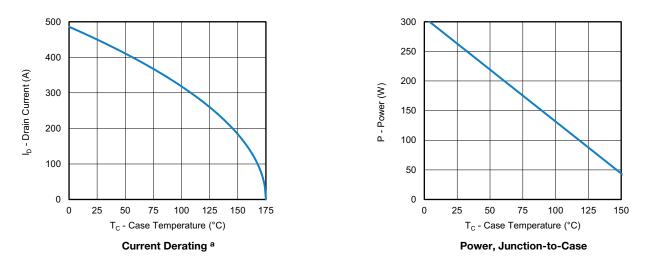
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

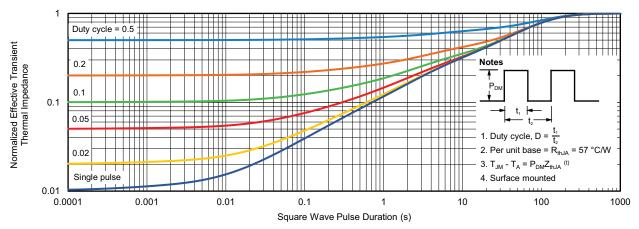
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



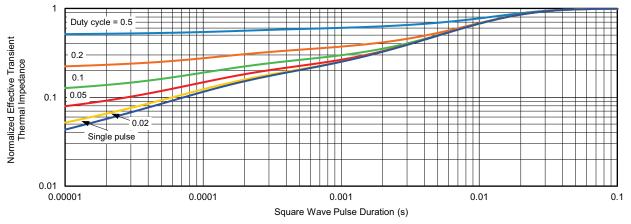
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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